

BB181 VHF variable capacitance diode Rev. 03 — 16 February 2009

Product data sheet

Product profile

1.1 General description

The BB181 is a variable capacitance diode, fabricated in planar technology and encapsulated in the SOD523 (SC-79) ultra small plastic SMD package.

1.2 Features

- Excellent linearity
- Ultra small plastic SMD package
- C_{d(28V)}: 1 pF; C_{d(0V5)} to C_{d(28V)} ratio : 14

1.3 Applications

- Electronic tuning in satellite tuners
- Tunable coupling
- Voltage Controlled Oscillators (VCO)

Pinning information 2.

Table 1. **Pinning**

Pin	Description	Simplified outlin	ne Graphic symbol
1	cathode	[1]	JL
2	anode	1 2	sym008

^[1] The marking bar indicates the cathode.

Ordering information 3.

Table 2. **Ordering information**

Type number	Package	Package			
	Name	Description	Version		
BB181	SC-79	plastic surface mounted package; 2 leads	SOD523		



VHF variable capacitance diode

4. Marking

Table 3. Marking codes

Type number	Marking code
BB181	N

5. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions Mi	in	Max	Unit
V_{R}	reverse voltage	-		30	V
I _F	forward current	-		20	mΑ
T _{stg}	storage temperature	-5	55	+150	°C
Tj	junction temperature	-5	55	+150	°C

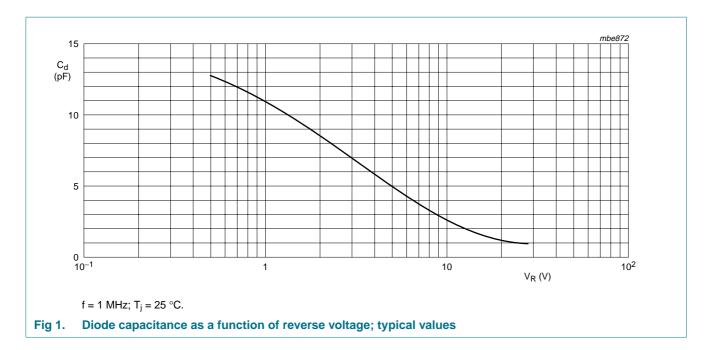
6. Characteristics

Table 5. Characteristics

 $T_i = 25 \,^{\circ}C$ unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
I _R rever	reverse current	see Figure 2				
		$V_R = 30 \text{ V}$	-	-	10	nA
		$V_R = 30 \text{ V}; T_j = 85 ^{\circ}\text{C}$	-	-	200	nA
r _s	diode series resistance	$f = 470 \text{ MHz}$ at $C_d = 9 \text{ pF}$	-	-	3	Ω
C _d	diode capacitance	f = 1 MHz; see <u>Figure 1</u> and <u>Figure 3</u>				
		$V_{R} = 0.5 V$	8	-	17	pF
		V _R = 28 V	0.7	-	1.055	pF
C _{d(0V5)} /C _{d(28V)}	diode capacitance ratio (0.5 V to 28 V)	f = 1 MHz	12	-	16	

VHF variable capacitance diode



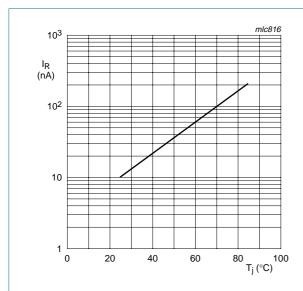
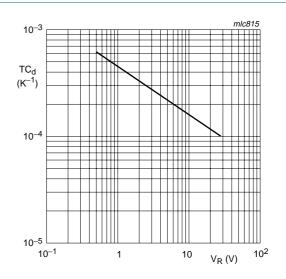


Fig 2. Reverse current as a function of junction temperature; maximum values



 $T_j = 0$ °C to 85 °C.

Fig 3. Temperature coefficient of diode capacitance as a function of reverse voltage; typical values

VHF variable capacitance diode

7. Package outline

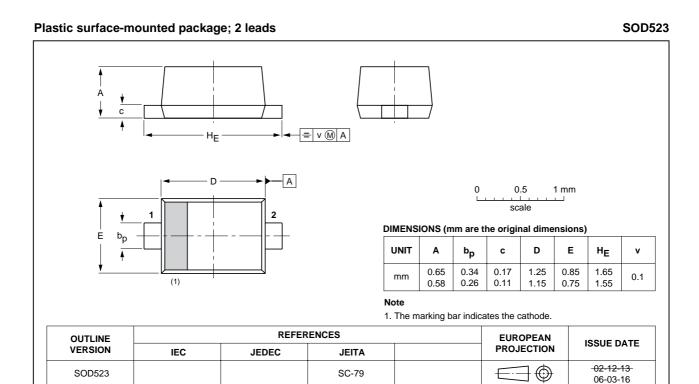


Fig 4. Package outline SOD523 (SC-79)

8. Abbreviations

Table 6. Abbreviations

Acronym	Description
SMD	Surface Mounted Device
VHF	Very High Frequency

9. Revision history

Table 7. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BB181_3	20090216	Product data sheet	-	BB181_N_2
Modifications:		of this data sheet has been re standard of NXP semiconduc		th the new presentation and
BB181_N_2	20080102	Product data sheet	-	BB181_1
BB181_1	19981126	Product specification	-	-

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VHF variable capacitance diode

10. Legal information

10.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
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VHF variable capacitance diode

12. Contents

1	Product profile	1
1.1	General description	1
1.2	Features	1
1.3	Applications	1
2	Pinning information	1
3	Ordering information	1
4	Marking	2
5	Limiting values	2
6	Characteristics	2
7	Package outline	4
8	Abbreviations	4
9	Revision history	4
10	Legal information	5
10.1	Data sheet status	5
10.2	Definitions	5
10.3	Disclaimers	5
10.4	Trademarks	5
11	Contact information	5
12	Contents	6

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Date of release: 16 February 2009

Document identifier: BB181_3